IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar

Examiner:

Dao H Nguyen

Serial No.:

10/789,882

Group Art Unit:

2818

Filed:

February 27, 2004

Docket:

303.673US3

Title:

INTEGRATED CIRCUIT AND SEED LAYERS

MAY 0 7 2007

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicant respectfully requests that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicant requests that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicant with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants hereby authorize the Commissoner to charge the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p), to Deposit Account No. 19-0743. Please charge any additional fees or credit any overpayment to Deposit Account No. 19-0743.

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Filing Date: February 27, 2004

Title: INTEGRATED CIRCUIT AND SEED LAYERS

The Examiner is invited to contact the Applicant's Representative at the below-listed telephone number if there are any questions regarding this communication.

Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications, and Non-Published Applications identifiable by USPTO Serial Number, are no longer required to be provided to the Office. Notification of this change to this effect was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004 and October 19, 2004. Thus, Applicant has not included copies of any US Patents or US Patent Applications identifiable by serial number that may be cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's below-signed representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

Respectfully submitted,

PAUL A. FARRAR

By his Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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Minneapolis, MN 55402

(612) 371-2157

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, ___ day of May 2007.

Alexendria, VA 22313-1450 on this

Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE **Application Number** 10/789,882 STATEMENT BY APPLICANT Use as many sheets as necessary February 27, 2004 **Filing Date** Farrar, Paul **First Named Inventor Group Art Unit** 2818 **Examiner Name** Nguyen, Dao Attorney Docket No: 303.673US3 Sheet 1 of 1

US PATENT DOCUMENTS							
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate			
	US-20010002333A1	05/31/2001	Huang, Chao-Yuan , et al.	03/29/1999			
	US-20020167089A1	11/14/2002	Ahn, Kie Y., et al.	05/14/2001			
	US-20060292857A1	12/28/2006	Ahn, K. Y., et al.	07/20/2006			
	US-20070085213A1	04/19/2007	Ahn, K. Y., et al.	12/14/2006			
	US-5,451,804	09/19/1995	Lur, W., et al.	11/16/1994			
	US-6,022,802	02/08/2000	Jang, Syun-Ming	03/18/1999			
	US-7,211,512	05/01/2007	Ahn, K. Y., et al.	01/18/2000			

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	T²		

	OTHER	R DOCUMENTS NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No 1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s),	T²
		publisher, city and/or country where published.	

DFW/

S/N 10/789,882

PATENT

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Paul A. Farrar

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COMMUNICATION CONCERNING RELATED APPLICATION(S)

MS Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

Serial/Patent No. 11639020	Filing Date/Issue Date December 14, 2006	Attorney Docket 303.672US3	Title SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION
11652310	January 11, 2007	303.648US5	METHODS FOR MAKING INTEGRATED-CIRCUIT WIRING FROM COPPER, SILVER, GOLD, AND OTHER METALS
11706662	February 15, 2007	303.672US4	SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted, PAUL A. FARRAR

By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938

Minneapolis, MN 55402

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Date $2 M_{Q_1} 20$

Βv

David R. Cochran

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450,

Alexandria, VA 22313-1450, on this _____day of May, 2007.

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Signature